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MEMC 2987 (00-2950)
PATENT

#6

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Ng, et al.

Art Unit: 2812

Serial No.: 09/970,404

Filed: October 3, 2001

Confirmation No.: 9398

For: APPARATUS AND PROCESS FOR PRODUCING POLISHED
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December 12, 2002

TO THE COMMISSIONER FOR PATENTS,

SIR:

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

In accordance with 37 C.F.R. 1.97 and 1.98 and MPEP 609, and in compliance with the duty of disclosure set forth in 37 C.F.R. 1.56, applicants submit copies of the references listed on the attached PTO/SB/08A for consideration by the Patent and Trademark Office in the above-entitled application and to be made of record therein.

I certify that each item contained in this statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement. A copy of one reference cited in the foreign search report, European Patent Application Number EP 0868977 A2, is not being submitted herewith because the reference has already been made of record as reference number 4 in the Information Disclosure Statement dated January 3, 2002

Respectfully submitted,

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PTO/SB/08A				Complete if Known	
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)				Application Number	09/970,404
				Filing Date	October 3, 2001
				Confirmation Number	9398
				First Named Inventor	Ng, et al.
				Group Art Unit	2812
				Examiner Name	Gregory E. Webb
Sheet	1	of	1	Attorney Docket No.	MEMC 2987 (00-2950)

U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. ¹	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY
		Number	Kind Code ² (if known)		
	7	5,605,487		Hileman et al.	02-25-1997

FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No. ¹	Foreign Patent Document			Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	T ⁶
		Office	Number ⁴	Kind Code ² (if known)			
	8	WO	01/60567	A1	MEMC Electronic Materials, Inc.	08-23-2001	

OTHER ART - NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.) date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ⁶
	9	International Search Report from the European Patent Office mailed November 29, 2002	

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Examiner Signature		Date Considered	
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached or place an "A" here if English language abstract is attached.

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